



MDQ50

High-end Power Semiconductor Manufacturer

**Single Phase Rectification Bridge Modules****Features:**

- Isolated mounting base 2500V
- Solder joint technology
- Space and weight savings

 **$I_o$  50 A** **$V_{RRM}$  2200 V** **$I_{FSM}$  0.5 KA** **$I^2t$   $1.25 \times 10^3 A^2s$** **Typical Applications**

- DC Power supplies for equipments.
- DC supply for PWM inverter
- Inverter Welder

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	$T_j(^{\circ}C)$	VALUE			UNIT
				Min	Type	Max	
$I_o$	DC output current	Single-phase full wave rectifying circuit, $T_c=100^{\circ}C$	150			50	A
$I_{RRM}$	Repetitive peak current	at $V_{RRM}$	150			8	mA
$I_{FSM}$	Surge forward current	10ms half sine wave $V_R=0$	150			0.5	kA
$I^2t$	$I^2T$ for fusing coordination					1.25	$A^2s \times 10^3$
$V_{FO}$	Threshold voltage		150			0.7	V
$r_F$	Forward slop resistance					6.0	mW
$V_{FM}$	Peak forward voltage	$I_{FM}=75A$	25			1.25	V
$R_{th(j-c)}$	Thermal resistance Junction to case	Single side cooled, per total				0.24	$^{\circ}C / W$
$R_{th(c-h)}$	Thermal resistance case to heatsink	Single side cooled, per total				0.07	$^{\circ}C / W$
$V_{iso}$	Isolation voltage	50Hz, R.M.S, $t=1min, I_{iso}:1mA(max)$		2500			V
$F_m$	Terminal connection torque(M5)				4.0		N·m
	Mounting torque(M5)				4.0		N·m
$T_{vj}$	Junction temperature			-40		150	$^{\circ}C$
$T_{stg}$	Stored temperature			-40		125	$^{\circ}C$
$W_t$	Weight				120		g
Outline		T12					

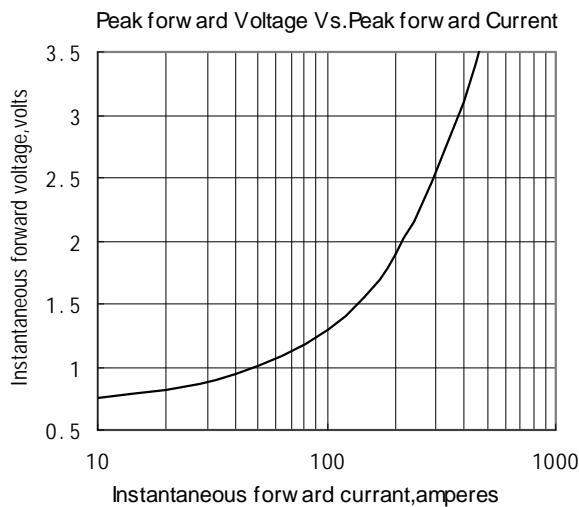


Fig.1

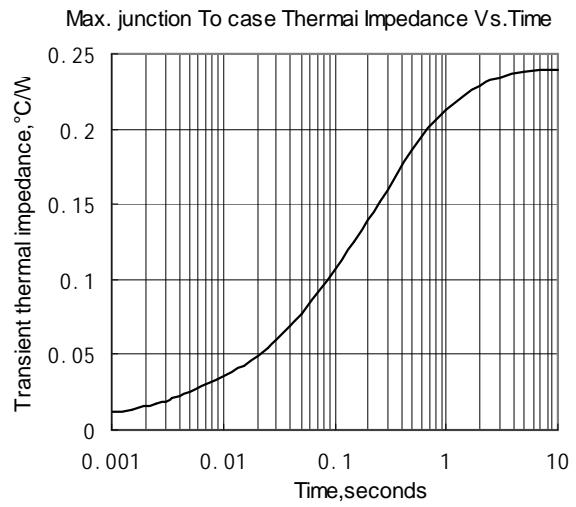


Fig.2

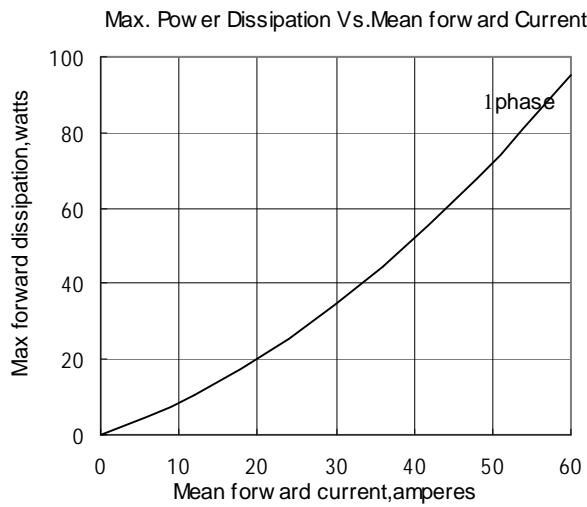


Fig.3

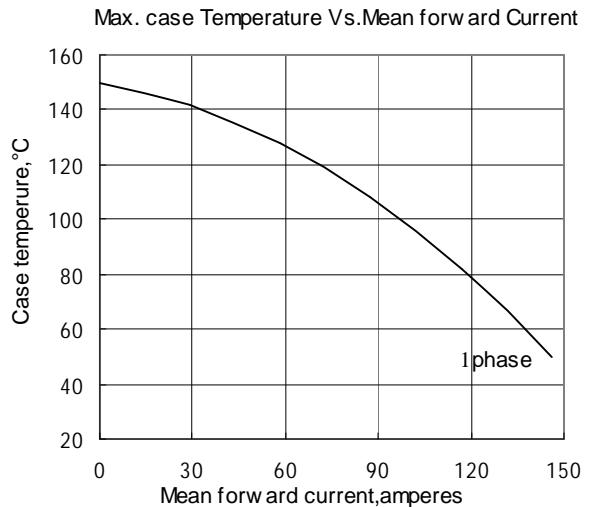


Fig.4

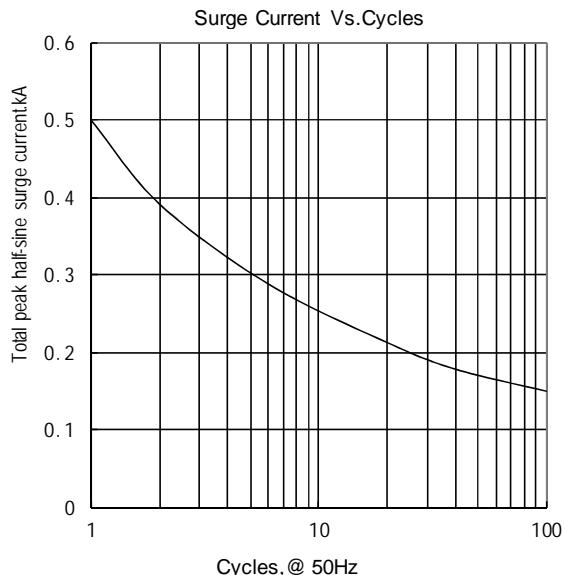


Fig.5

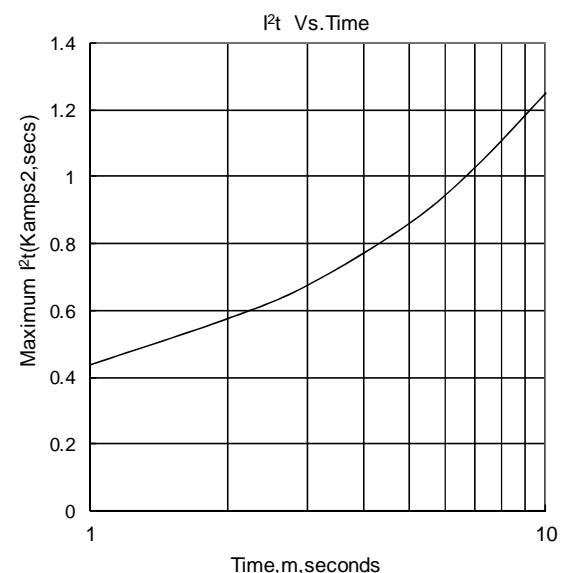
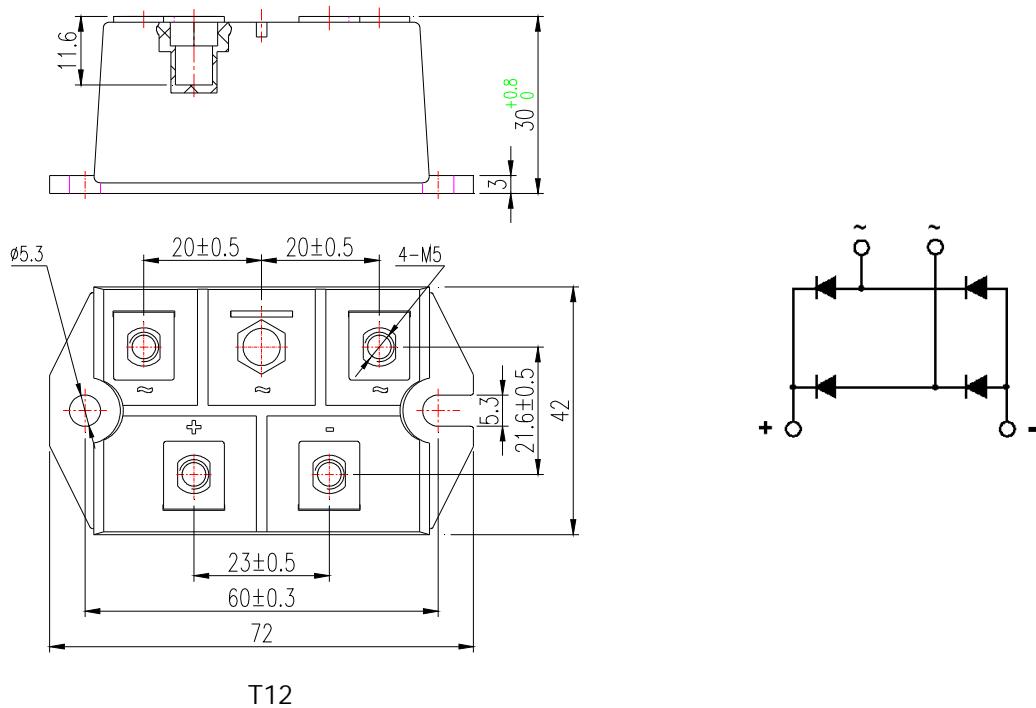


Fig.6

**Outline:**

T12